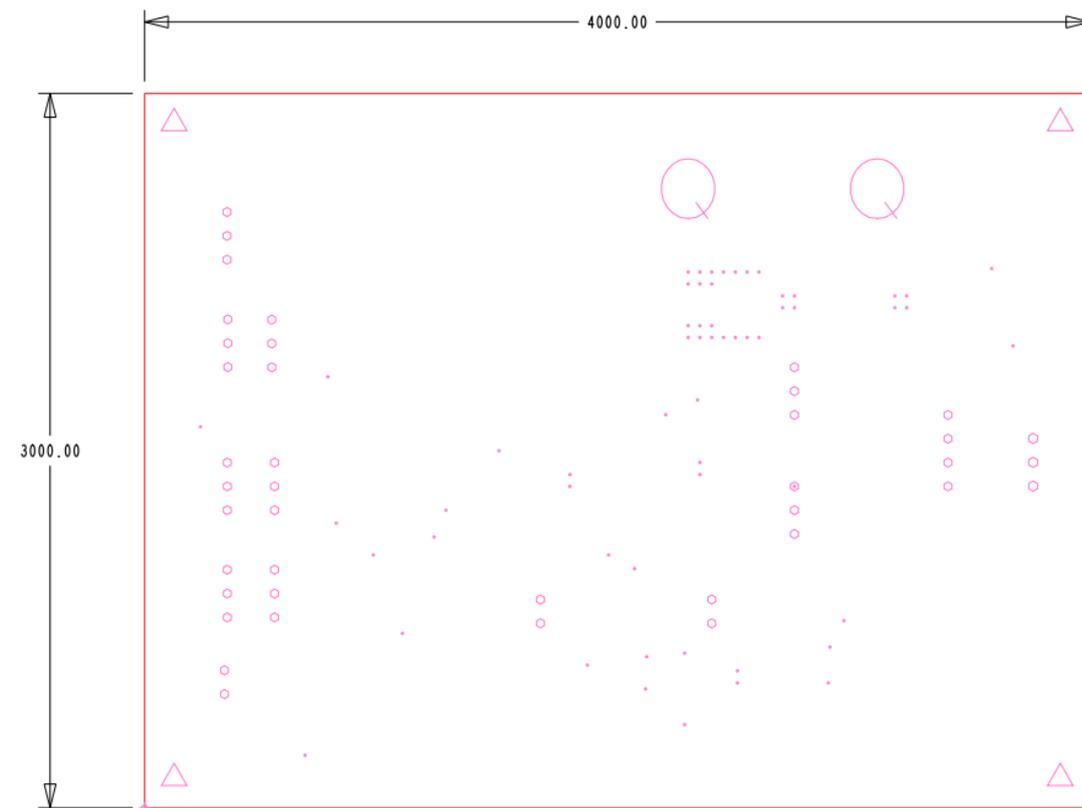
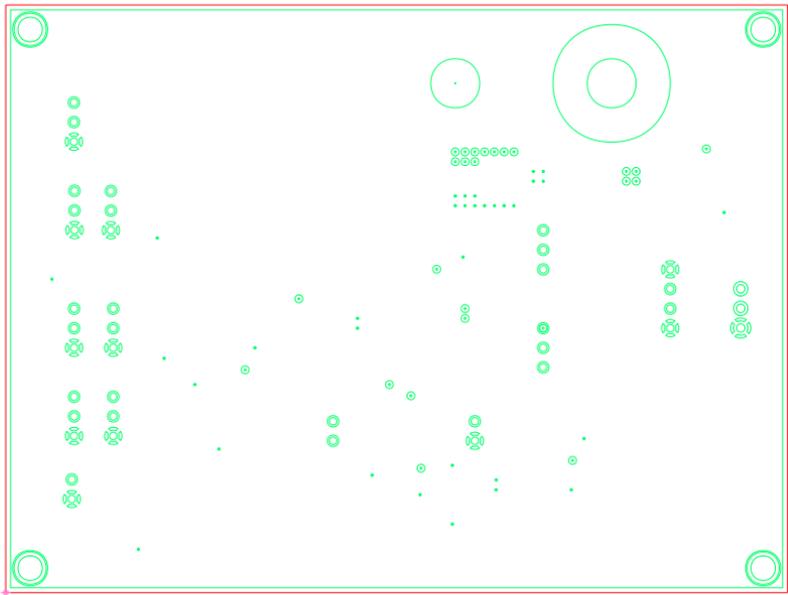
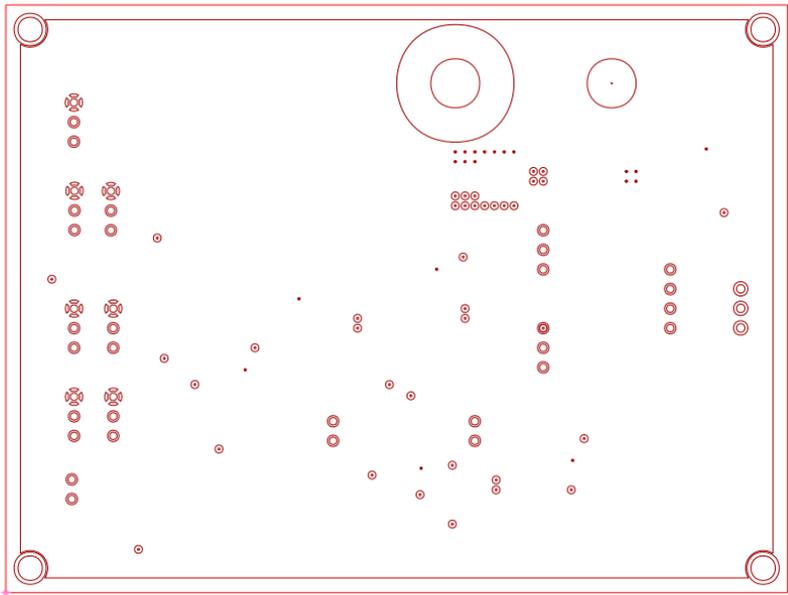


DRILL CHART: TOP to BOTTOM				
ALL UNITS ARE IN MILS				
FIGURE	SIZE	TOLERANCE	PLATED	QTY
.	10.0	+3.0 / -3.0	PLATED	58
◦	38.0	+3.0 / -3.0	PLATED	37
◦	43.0	+3.0 / -3.0	PLATED	3
Q	250.0	+0.0 / -0.0	PLATED	2
△	125.0	+2.0 / -2.0	NON-PLATED	4





LAYER 02 - GND PLANE



LAYER 03 - PWR PLANE

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